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## ABSTRACT OF THE DISCLOSURE

A polypropylene resin composition for a film for metallization, which comprises 100 parts by weight of a polypropylene resin and 0.01 to 1 part by weight of a phosphite represented by the general formula (I):

$$R_2$$
 $R_3$ 
 $R_3$ 
 $R_3$ 
 $R_4$ 
 $R_3$ 
 $R_4$ 
 $R_5$ 
 $R_5$ 
 $R_5$ 

(wherein, R<sup>1</sup>, R<sup>2</sup>, R<sup>4</sup> and R<sup>5</sup> represent individually hydrogen, an alkyl, cycloalkyl, alkylcycloalkyl, aralkyl or phenyl; R<sup>3</sup> represents hydrogen or an alkyl; X represents sulfur atom or a -CHR<sup>5</sup>- group (R<sup>5</sup> represents hydrogen, an alkyl or cycloalkyl); n is 0 or 1; A is an alkylene or a \*-CO(R<sup>7</sup>)m-group (R<sup>7</sup> is an alkylene, \* mark is indicative of the bonding site of A to oxygen and m is 0 or 1); and either one of Y or Z is hydroxy, alkoxy or aralkyloxy and the other is hydrogen or an alkyl.), a film thereof, and a metallized film thereof.